



FANGCHENG ELECTRON  
FANGCHENG ELECTRONICS (DONGGUAN) CO., LTD.

方成电子（东莞）有限公司

Fang cheng Electronics(Dong guan) Co,LTD

SPECIFICATION FOR APPROVAL

CUSTOMER:

Part Number :

CUSTOMER Number:

CUSTOMER Part :

Fangcheng part :

DATE:

REV:



Confidential

made in fangcheng:

CUSTOMER APPROD:

| prepad | checd | Approd     |
|--------|-------|------------|
| 黄敏     | 罗佳    | Jason Yuan |

| prepad | checd | Approd |
|--------|-------|--------|
|        |       |        |

THE INFORMATION CONTAINED IN THIS DOCUMENT IS OF A PROPRIETARY NATURE AND IS INTENDED TO BE KEPT CONFIDENTIAL BETWEEN THE SENDER AND THE INTENDED RECIPIENT. IT MAY NOT BE REPRODUCED OR USED WITHOUT EXPRESS WRITTEN PERMISSION OF FC TECHNOLOGIES, OR FC

**Fangcheng Electronics (Dongguan) Co., Ltd.**

Tel: +86 0769-82988010

Fax: +86 0769-82988065

E-mail: yhl@fangchengcoils.com

URL: www.fangchengcoils.com

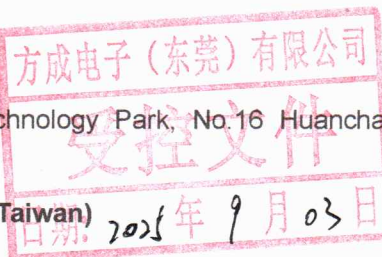
Address: Building 3, Jinmei Technology Park, No.16 Huanchang West Road, Changping Town, Dongguan City

Fangcheng Electronics (China-Taiwan)

Address: No. 31, MRT Road, Zhonghe District, New Taipei City

Tel: +8869-983491379

Postcode: 235050



made : 方成电子 (东莞) 有限公司

Page: 2 ----- 8

[illegible]

黄敏

罗佳

**Jason Yuan**

Customer:

made : 方成电子(东莞)有限公司

Part Number: FC-TN3220-110-70A-L

Page: 3 ----- 8

## Notice of Use

For the parameters not prescribed in the *Specification for Approval*, please refer to the following standards or the relative industry standards.

1. Product in packing storage condition : temperature 540, RH70%.

2. A storage of - F C -Electronic products for longer than 12 months is not recommended. Within other effects, the terminals may suffer degradation, resulting in bad solderability. Therefore, all products shall be used within the period of 12 months based on the day of shipment.

3. Do not keep products in unsuitable storage conditions, such as areas susceptible to high temperatures, high humidity, dust or corrosion.

4 Always handle products with care.

5 Don't touch electrodes directly with bare hands as oil secretions may inhibit soldering.

Always ensure optimum conditions for soldering.

6 When this product will be used on a similar or new project to the original one, sometimes it might be unable to satisfy the specifications due to different condition of usage.

7 This inductor itself does not have any protective function in abnormal condition, such as overload, short-circuit, open-circuit conditions, etc. Therefore, it shall be confirmed that there is no risk of smoke, fire, dielectric withstand voltage, insulation resistance, etc., or use in abnormal conditions protective devices or protection circuit in the end product.

8 Hi-Pot test with higher voltage than spec value will damage insulating material and shorten its life.

IPC 020D Joint Industry standard

IEC1007 《Transformer and inductors for use in electronic and telecommunication equipment—Measuring methods and test procedures》

(ROHS or other environmental request)



中国认可  
国际互认  
CNAS CO28-M

受控文件

环境管理体系认证证书-编号:02825E11713R0S

质量管理体系认证证书-编号:02825Q12617R0S



Prepad

黄敏

Checkd

罗佳

Approd

Jason Yuan



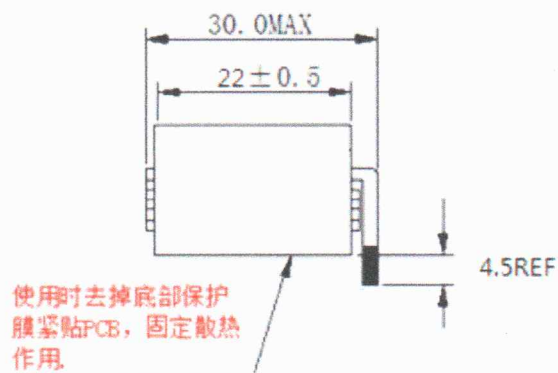
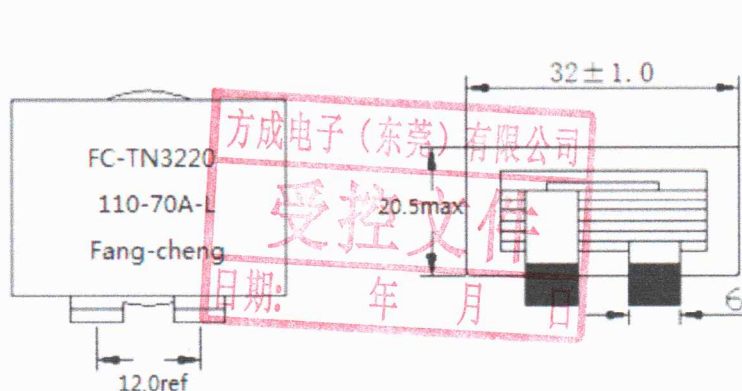
Customer:

made : 方成电子(东莞)有限公司

Part Number: FC-TN3220-110-70A-L

Page: 4 ----- 8

## 1. Appearance and Dimensions(mm)



## 2. Schematic :



## General Properties:

It is recommended that the temperature of the component does not exceed +125°C under worst case conditions

Storage Temperature (in original packaging)

-20 °C up to +60 °C

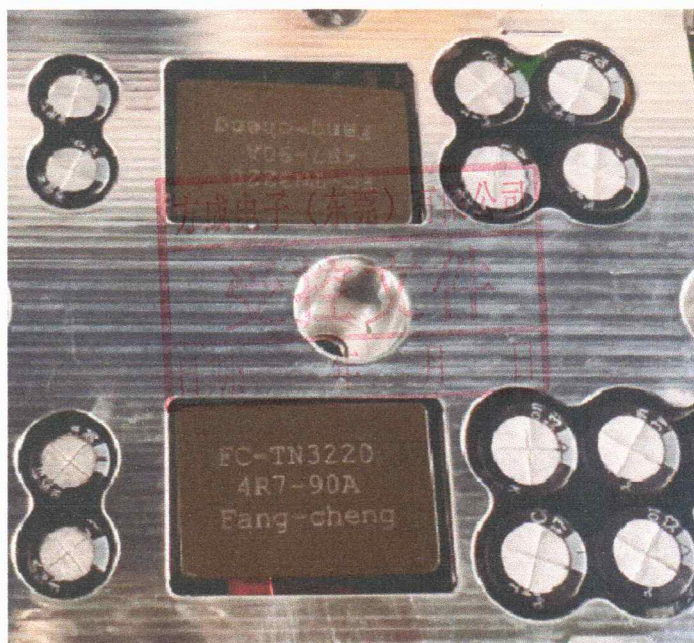
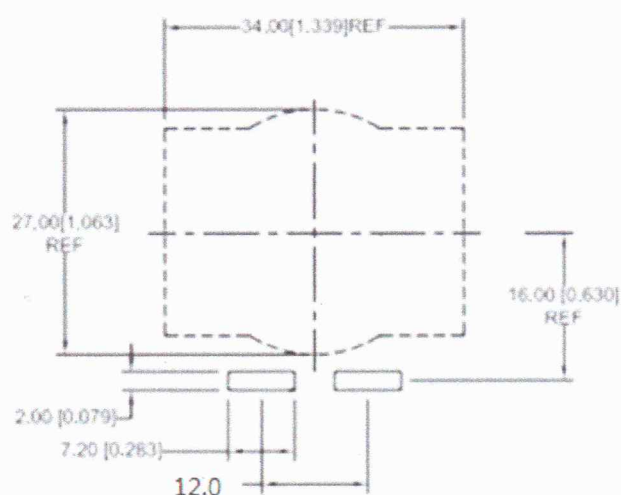
Operating Temperature

-40 °C up to +125 °C

Temperature Rise < 55K

Test conditions of Electrical Properties: +20°C, 33% RH if not specified differently

## 3. PCB LAYOUT:(mm)



Prepad

黄敏

Checkd

罗佳

Approd

Jason Yuan

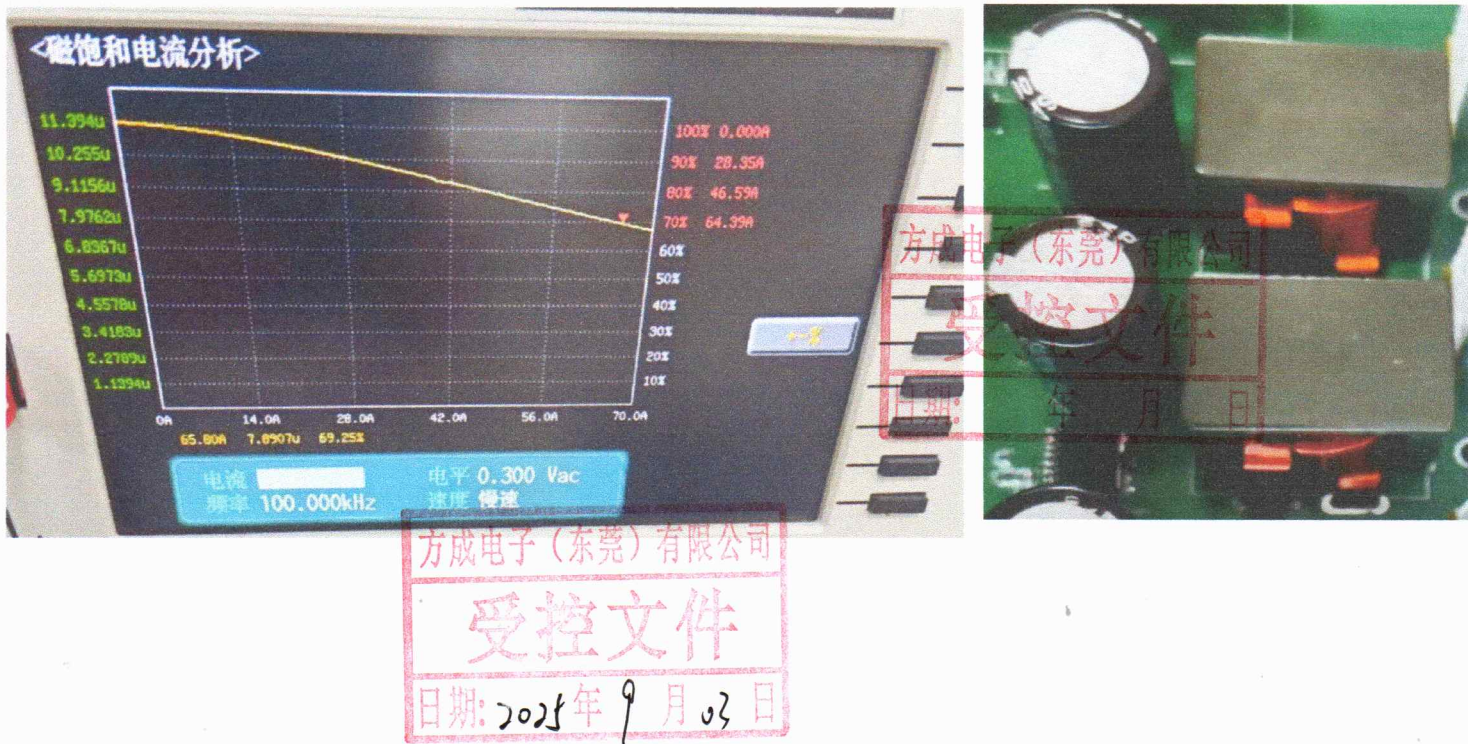


4. Electrical Characteristics :

| NO<br>序号 | PARAMETER<br>参数   | TERMINAL<br>脚位 | SPCIFICATION<br>规格   | TEST INSTRUMENTS<br>测试设备                   |
|----------|-------------------|----------------|----------------------|--------------------------------------------|
| 1        | INDUCTANCE<br>电感量 | L=(S-F)        | 11.0uH±20%           | 100KHz,0.3V WK3260<br>CHROMA 3250 or EQUAL |
| 2        | 工作电流              | I=(S-F)        | DC=70A/max,65.0A Typ | WK3260B                                    |
|          | 磁饱和电流             | I=(S-F)        | DC=65A/MAX/65.0ATyp  | WK3260B                                    |
| 3        | 工作频率              | L=(S-F)        | 1KHZ-5.0MHZ/Min      | 6632                                       |
| 4        | DCR               | R=(S-F)        | 1.5typ/2.0mΩ Max     | CH502BC                                    |
| 5        | 高压测试              | 绕组-磁芯          | DC/500 V             | CH7350                                     |
| 6        | 绝缘阻抗              | 绕组-磁芯          | 100M.Ω / 500VDC      | CH7350                                     |

Low Primary DCR version  
Ambient temperature -40° C to +85° C  
Storage temperature Component: -40° C to +125° C

5. @Inductance VS.DC Current Curve.



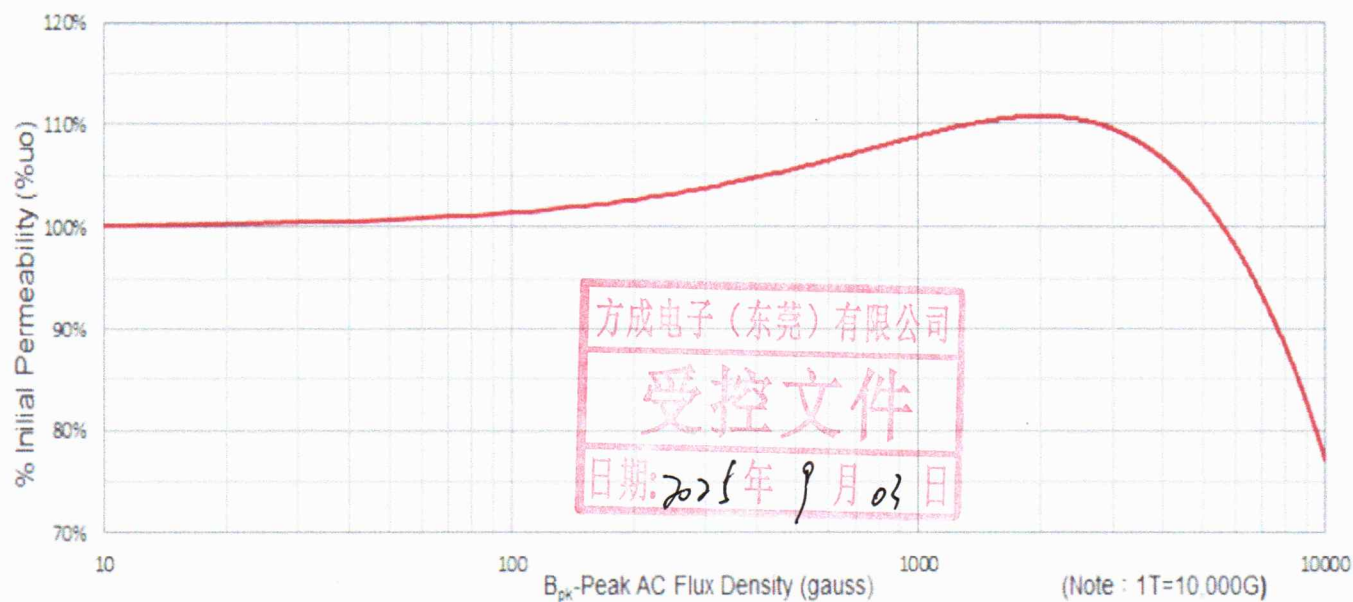
Customer:

made : 方成电子(东莞)有限公司

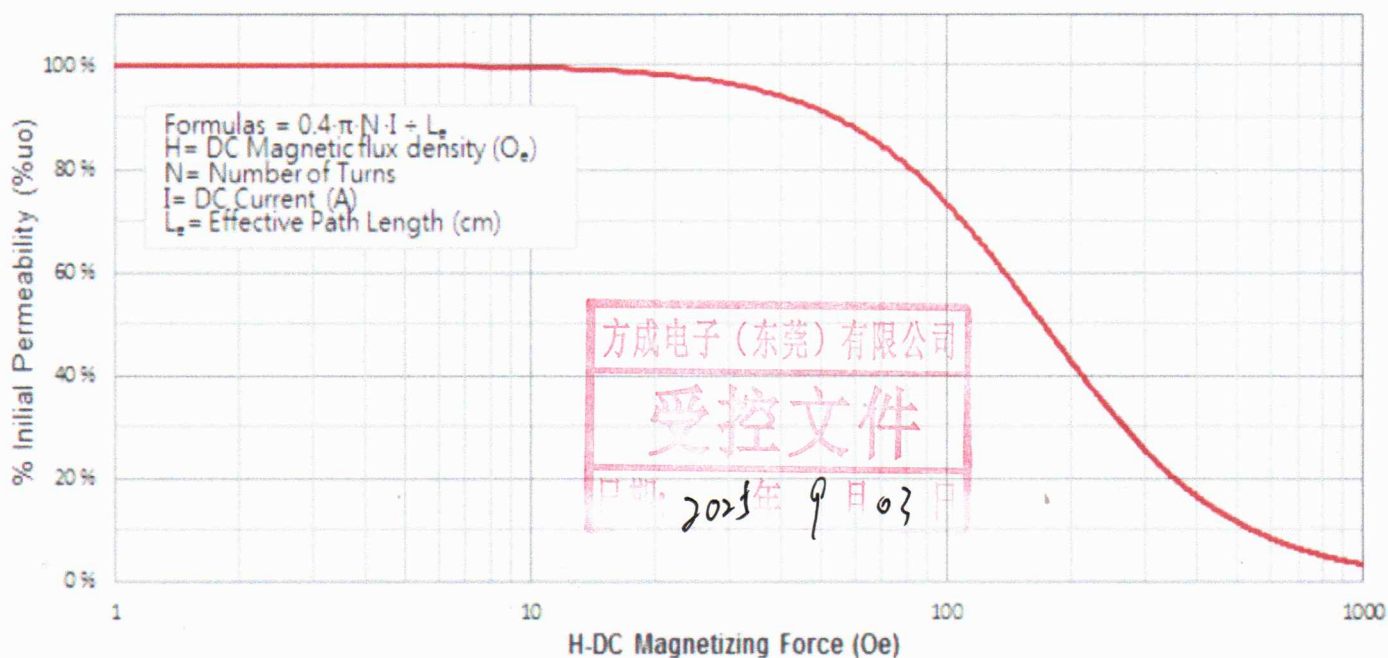
Part Number: FC-TN3220-110-70A-L

Page: 6 ----- 8

## 6. Percent Initial Permeability VS AC Flux Density



## 6.2 Percent Initial Permeability (%μ<sub>0</sub>) VS DC Magnetizing Force



Prepad

黄敏

Checkd

罗佳

Approd

Jason Yuan



Customer:

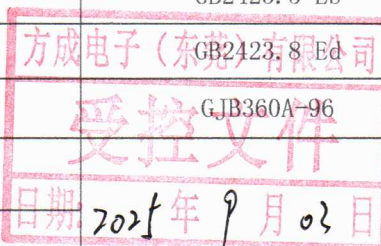
made : 方成电子(东莞)有限公司

Part Number: FC-TN3220-110-70A-L

Page: 7 ----- 8

## 7. Reliability and test condition:

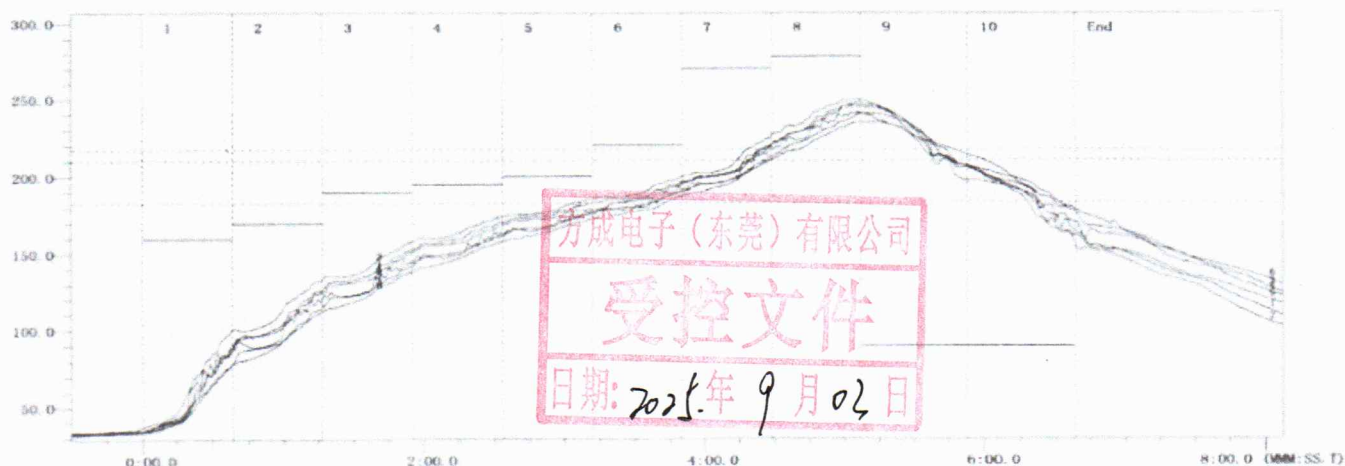
| Test item                                                       | test condition                  | Remark |
|-----------------------------------------------------------------|---------------------------------|--------|
| Cold Operating Test                                             | GB2423.1 Ad                     |        |
| Heat Operating Test                                             | GB2423.2 Bd                     |        |
| Cold Storage Test                                               | GB2423.1 Ab                     |        |
| Heat Storage Test                                               | GB2423.2 Bb                     |        |
| Steady Damp Heat Test                                           | GB2423.3 Cb                     |        |
| Circular Damp Heat Test                                         | GB2423.4 Db                     |        |
| Temperature Cycling Test                                        | GB2423.22 Nb                    |        |
| Temperature Shock Test                                          | GB2423.22 Na                    |        |
| Vibration Test                                                  | GB2423.10~15 Fc, Fdb            |        |
| Mechanical Shock Test(Bump)                                     | GB2423.5 Eb                     |        |
| Free Fall Test                                                  | GB2423.8 Ed                     |        |
| Solderability                                                   | GJB360A-96                      |        |
| High Temperature Step Stress Test                               | Enhancement Test Specifications |        |
| Low Temperature Step Stress Test                                |                                 |        |
| High-speed Thermal Cycling                                      |                                 |        |
| Limit Vibration                                                 |                                 |        |
| Composite Stress                                                |                                 |        |
| Highly-Accelerated Temperature and Humidity Stress Test(HAST) ( |                                 |        |



|              |             |                             |
|--------------|-------------|-----------------------------|
| Prepad<br>黄敏 | Checd<br>罗佳 | Approd<br><b>Jason Yuan</b> |
|--------------|-------------|-----------------------------|

## 8. Soldering Specification:

### 8.1 Reflow Profile for Components.



### 8.2 波峰焊温度: $255^{\circ}\text{C} \pm 5^{\circ}\text{C}$ ; 时间: 不少于 7 秒.

波峰焊预热温度:  $100$  至  $160^{\circ}\text{C}$ ; 时间: 不少于 10 秒.

### 8.3 高温耐热性:

在  $260^{\circ}\text{C}$  的熔融钎料中, 停留时间不少于 10 秒, 无质量问题.

### 8.4 返修温度和时间:

温度:  $350^{\circ}\text{C}$ ; 时间: 不少于 5 秒.

### 8.5 焊接次数:

元器件能承受的焊接次数不少于 5 次.



## 9.1 包装:

- 1) 包装箱上应标明产品型号、名称、数量、出厂日期、承制方名称及出厂检验章;
- 2) 货物运达客户方后, 包装箱封条应完好, 箱体无破损、开裂等现象;
- 3) 电感用木箱或其他材料包装, 方便拆卸, 四周用软性材料填充;

## 9.2 外观:

- 1) 产品应有合格证和耐擦防水洗标签, 应注明型号、规格;
- 2) 产品外观整洁, 应无破损、划伤;

## 9.3 检验:

- 1) 产品生产中必须全数进行电气性能, 抗电强度检测; 箱内应有 100% 电气性能合格保证书或检测报告;
- 2) 产品出货前按批次, 必须根据承认书按国家行业标准进行抽样检验, 合格后出具出厂检验报告, 记录抽样测试数据,

|              |             |                      |
|--------------|-------------|----------------------|
| Prepad<br>黄敏 | Checd<br>罗佳 | Approd<br>Jason Yuan |
|--------------|-------------|----------------------|